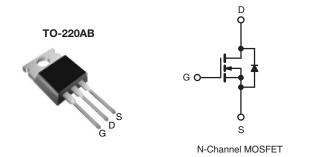


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	40	400			
R _{DS(on)} (Ω)	V _{GS} = 10 V	3.6			
Q _g (Max.) (nC)	17	,			
Q _{gs} (nC)	3.4	3.4			
Q _{gd} (nC)	8.5				
Configuration	Sing	Single			



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF710PbF
Lead (FD)-iree	SiHF710-E3
SnPb	IRF710
SHED	SiHF710

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	400	- v	
Gate-Source Voltage			V_{GS}	± 20		
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C		2.0	А	
		T _C = 100 °C	I _D	1.2		
Pulsed Drain Current ^a			I _{DM}	6.0	1	
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	120	mJ	
Repetitive Avalanche Current ^a			I _{AR}	2.0	Α	
Repetitive Avalanche Energy ^a			E _{AR}	3.6	mJ	
Maximum Power Dissipation	T _C = 25 °C		P_{D}	36	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d]	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 52 mH, R_g = 25 Ω , I_{AS} = 2.0 A (see fig. 12).
- c. $I_{SD} \le 2.0$ A, $dI/dt \le 40$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.5	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.47	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} :	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		-	4.0	V
Gate-Source Leakage	I_{GSS}		V _{GS} = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{V}, V_{GS} = 0 \text{ V}, T_J = 125 ^{\circ}\text{C}$		-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.2 A ^b	-	-	3.6	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 1.2 A ^b		1.0	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	170	-	pF
Output Capacitance	C _{oss}			-	34	-	
Reverse Transfer Capacitance	C_{rss}			-	6.3	-	
Total Gate Charge	Qg		I _D = 2.0 A, V _{DS} = 320 V see fig. 6 and 13 ^b	-	-	17	nC
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V		ı	-	3.4	
Gate-Drain Charge	Q_{gd}]		ı	-	8.5	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 200 V, I_{D} = 2.0 A, R_{g} = 24 Ω , R_{D} = 95 Ω see fig. 10 ^b		ı	8.0	-	- ns
Rise Time	t _r			ı	9.9	-	
Turn-Off Delay Time	$t_{d(off)}$			ı	21	-	
Fall Time	t _f			ı	11	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L _S			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.0	^
Pulsed Diode Forward Current ^a	I _{SM}			-	-	6.0	A A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 2.0 A, V _{GS} = 0 V ^b		-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 2.0 A, dl/dt = 100 A/μs ^b		-	240	540	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.85	1.6	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _I				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

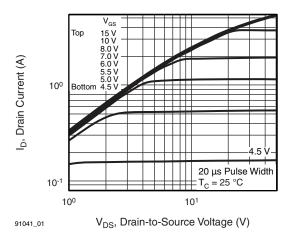


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

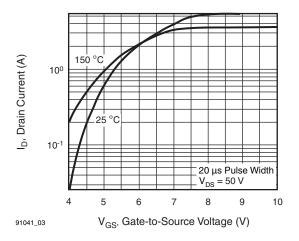


Fig. 3 - Typical Transfer Characteristics

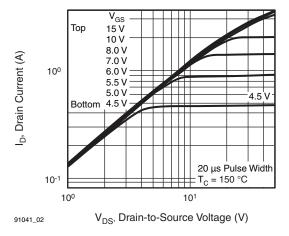


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

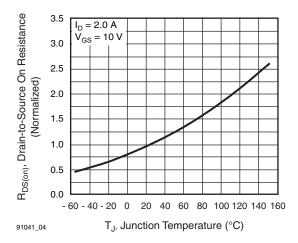
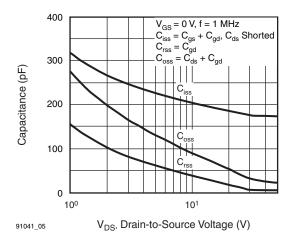


Fig. 4 - Normalized On-Resistance vs. Temperature





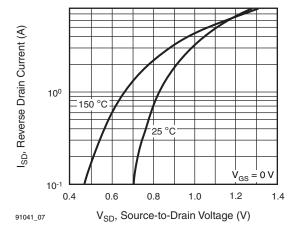


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage

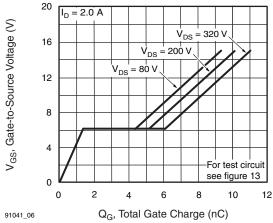


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

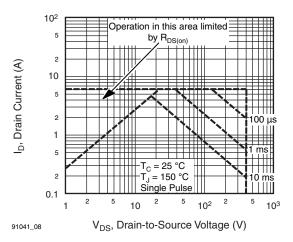


Fig. 8 - Maximum Safe Operating Area





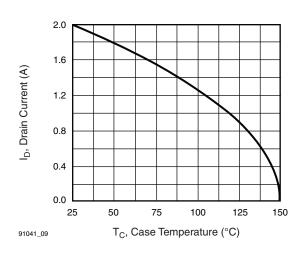


Fig. 9 - Maximum Drain Current vs. Case Temperature

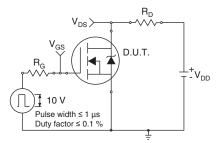


Fig. 10a - Switching Time Test Circuit

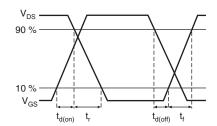


Fig. 10b - Switching Time Waveforms

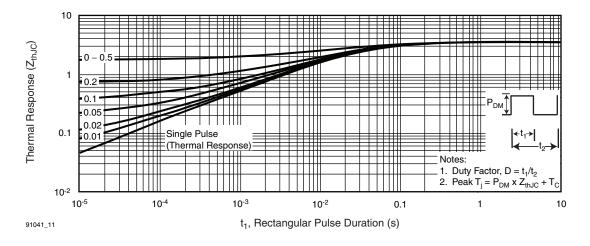


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



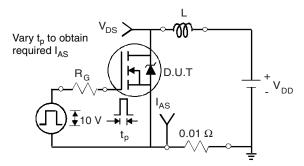


Fig. 12a - Unclamped Inductive Test Circuit

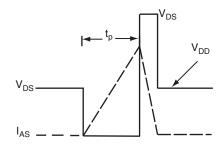


Fig. 12b - Unclamped Inductive Waveforms

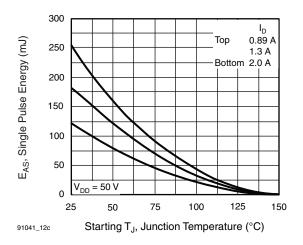


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

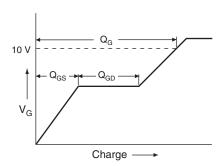


Fig. 13a - Basic Gate Charge Waveform

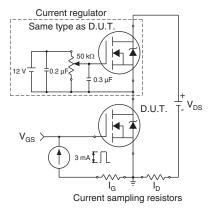
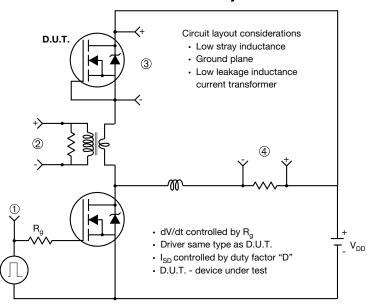


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



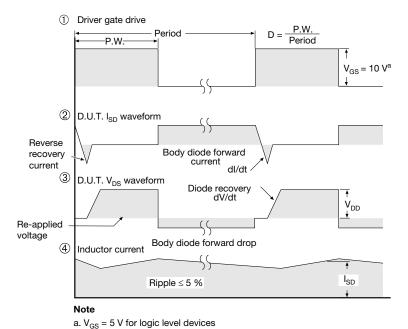


Fig. 14 - For N-Channel

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